

#### **Features**

- Top view 0402 package
- Viewing Angle = ±60°
- Compatible with infrared and vapor phase reflow solder process
- High reliability
- Ultra bright Green
- RoHS compliance

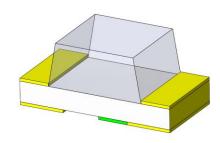
### **Applications**

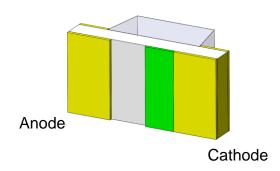
- Optical indicator.
- Switch and Symbol Display.

### **Description**

The GP100505-CTC3 is an AlGalnP Green LED housed in a miniature SMD package. The device has a dominant wavelength of 524nm LED.

## **Package Outline**





#### **Schematic**

Cathode 
$$\longrightarrow$$
 Anode  $(-)$ 



## Absolute Maximum Rating at 25°C

Symbol	Parameters	Ratings	Units	Notes
l <sub>F</sub>	Continuous Forward Current	25	mA	
I <sub>FP</sub>	Peak Forward Current	60	mA	1
V <sub>R</sub>	Reverse Voltage	5	V	
Topr	Operating Temperature	-40 ~ +85	°C	
T <sub>stg</sub>	Storage Temperature	-40 ~ +100	°C	
T <sub>sol</sub>	Soldering Temperature	260	°C	2
PD	Power Dissipation at(or below) 25°C Free Air Temperature	95	mW	

### Electro-Optical Characteristics TA = 25°C (unless otherwise specified)

### **Optical Characteristics**

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
lv	Luminous Intensity	I <sub>F</sub> =5mA	200	-	500	mcd	3
λD	Dominant Wavelength	I <sub>F</sub> =5mA	516	•	532	nm	4
θ1/2	Angle of Half Intensity	I <sub>F</sub> =5mA	•	±60	-	deg	

#### **Electrical Characteristics**

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
VF	Forward Voltage	I <sub>F</sub> =5mA	2.6	-	3.2	V	5
I <sub>R</sub>	Reverse Current	V <sub>R</sub> =5V	-	-	1	μΑ	

#### Notes:

- 1. I<sub>FP</sub> Conditions--Pulse Width≦ 100µs and Duty≦ 10%.
- 2. Soldering time  $\leq 10$  seconds.



#### 3. Bin Range of Luminous Intensity

Bin Code	Min	Max	Unit	Condition
p1	200	250		
p2	250	300		
q1	300	350	mcd	I <sub>F</sub> =5mA
q2	350	400		
r1	400	500		

Tolerance of: Luminous Intensity  $\pm 10\%$ 

#### 4. Bin Range of Dominant Wavelength

Bin Code	Min	Max	Unit	Condition	
F1	516	520			
F2	520	524	nm	I <sub>F</sub> =5mA	
F3	524	528	nm		
F4	528	532			

Tolerance of Dominant Wavelength: ±1nm.

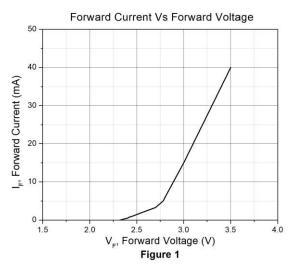
#### 5. Bin Range of Forward Voltage

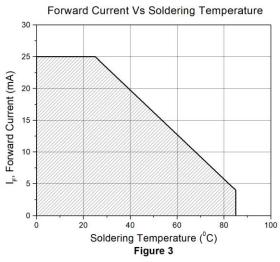
Bin Code	Min	Max	Unit	Condition	
33	2.6	2.7			
34	2.7	2.8			
35	2.8	2.9	V	I <sub>F</sub> =5mA	
36	2.9	3.0	V		
37	3.0	3.1			
38	3.1	3.2			

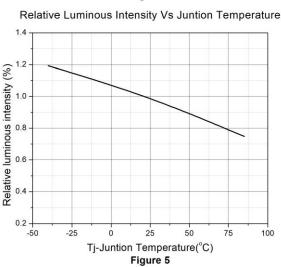
Tolerance of Forward Voltage  $\pm 0.05$ V.

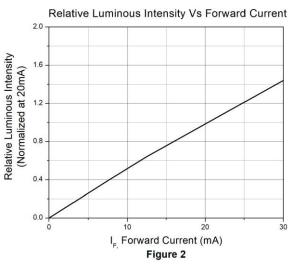


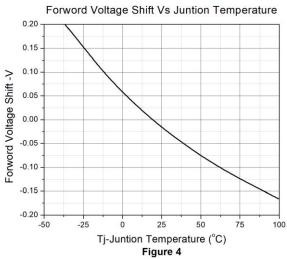
### **Typical Characteristic Curves**

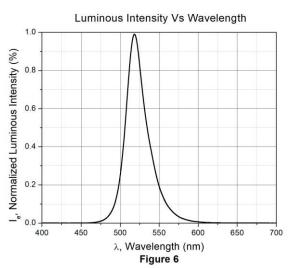






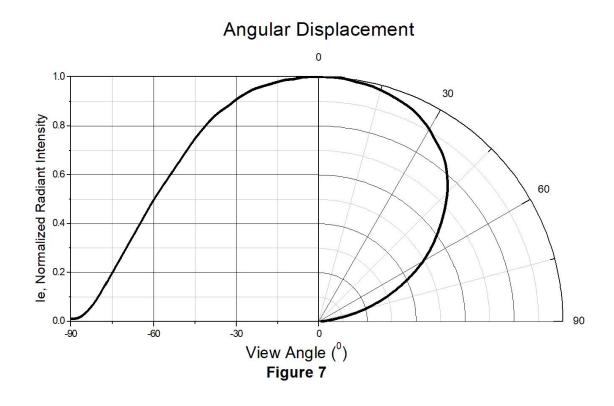






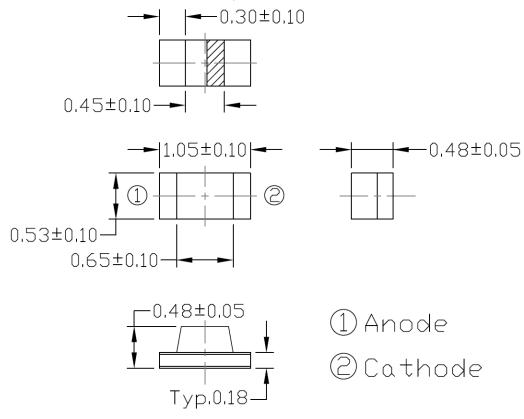


## **Typical Characteristic Curves**



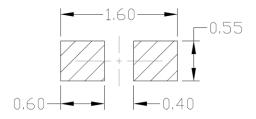


### Package Dimension All dimensions are in mm, unless otherwise stated



Note: Tolerance unless mentioned is ±0.1mm.

### Recommended Soldering Mask All dimensions are in mm, unless otherwise stated



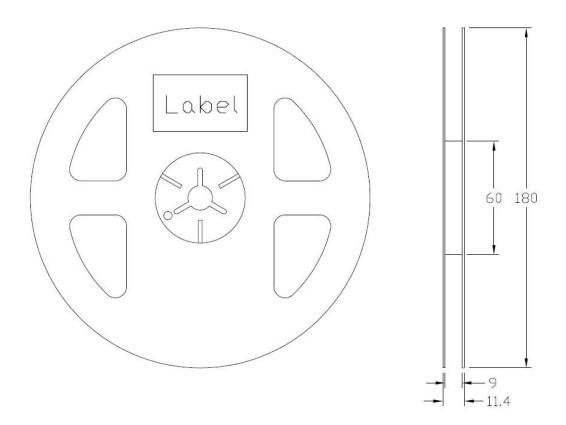
Note: Tolerance unless mentioned is ±0.1mm.

## **Ordering Information**

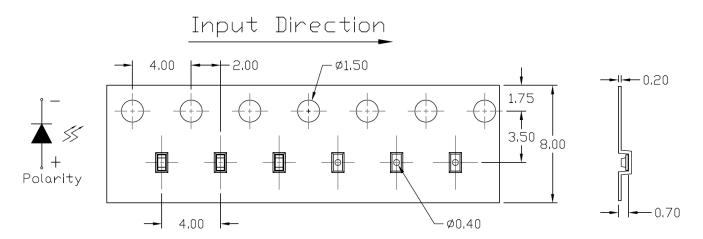
Part Number	Description	Quantity
GP100505-CTC3	Tape & Reel	3000 pcs



### Reel Dimension All dimensions are in mm, unless otherwise stated



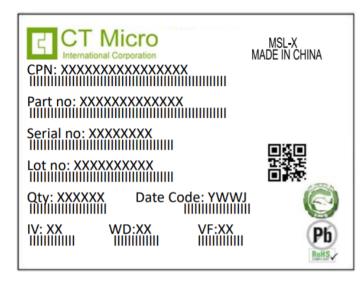
### Tape Dimension All dimensions are in mm, unless otherwise stated



Note: Tolerance unless mentioned is  $\pm 0.1$ mm.



### **Label Form Specification**



CPN : Customer Part Number Part no: CTM Production Number

Serial no: Production Number

Lot no: Lot number

Q'ty: Packing Quantity

Date Code: Manufacture Date

IV: Bin Code of Luminous Intensity

WD : Bin Code of Dominant Wavelength

VF : Bin Code of Forward Voltage

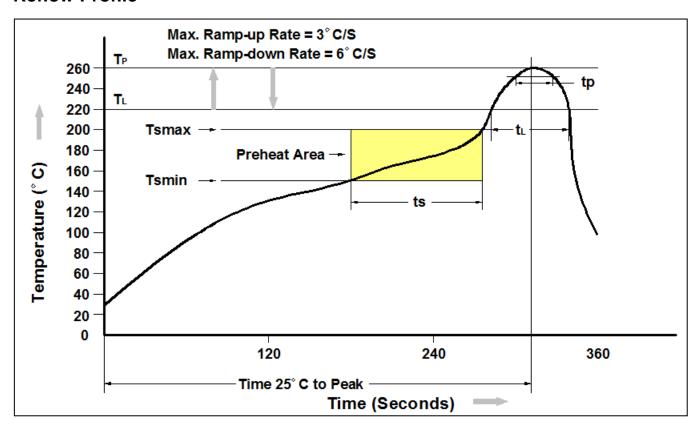
MADE IN CHINA: Production Place

### **Storage Condition**

- 1. Do not open moisture proof bag before the products are ready to use.
- 2. The moisture barrier bag should be stored at 30°C and 90%R.H. max. before opening. Shelf life of non-opened bag is 12 months after the bag sealing date.
- 3. After opening the moisture barrier bag floor life is 1 year at 30°C/60%RH. max. Unused LEDs should be resealed into moisture barrier bag. (Refer to J-STD-020 Standard)
- 4. If the moisture absorbent material has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the J-STD-033 Standard conditions.



### **Reflow Profile**



Profile Feature	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	150°C
Temperature Max. (Tsmax)	200°C
Time (ts) from (Tsmin to Tsmax)	60-120 seconds
Ramp-up Rate (t∟ to t⊳)	3°C/second max.
Liquidous Temperature (T <sub>L</sub> )	217°C
Time (t <sub>L</sub> ) Maintained Above (T <sub>L</sub> )	60 – 150 seconds
Peak Body Package Temperature	260°C +0°C / -5°C
Time (t₂) within 5°C of 260°C	30 seconds
Ramp-down Rate (T <sub>P</sub> to T <sub>L</sub> )	6°C/second max
Time 25°C to Peak Temperature	8 minutes max.



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